IPC ASSOCIATION CONNECTION ELECTRONICS INDUSTRIE	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfg Information			
upplier Inforn									,						
Company name*			Company unique ID			Ţ	Unique ID Authority					Response Date*			
nsemi											2025-06	2025-06-02			
Contact Name		Title - Contact			I	Phone - Contact*				Email - Contact*					
Product-Env-Stew	ards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
uthorized Repres	entative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
Product-Env-Stew	ards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Request	Requester Item Number Mfr Item		m Number Mfr Item Name				Effective Date	Versio	n l	Manufacturing Site		Weight*	UOM	Unit Type	
		MICROFJ-30035- TSV-TR J-Series 3mm 35u TS		TSV		2025-06-02		TH2			10.8	mg	Each		
Ianufacturing	Process Information	on													
Terminal Plating / Grid Array Material T			Ferminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Temperature Max Time at		re Max Time at Peal	k Tempera	ture Numb	per of Reflow Cyc	eles			
SnAgCu		C	CU Alloy 3		3		260	С 30		30	secon	nds 3			
omments															
TTENTION: MS	L 3 Rated item requires I	Bake and D	ry Pack (afte	r electrical test)											
or more informati	ion regarding material co	mposition 1	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct omponents, the declaration shall encompass all such components. Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.681	mg	Supplier	Silicon (Si)	7440-21-3		5.681	mg
Glass Attach Adhesive	0.536		Supplier	Isononane	34464-40-9		0.402	mg
			Supplier	Silicone	Proprietary Data		0.1233	mg
			Supplier	Other Additive Agents	Proprietary Data		0.0107	mg
Glass Lid /Cap	4.034		Supplier	Sodium Monoxide (Na2O)	1313-59-3		0.1614	mg
			Supplier	Silicon Dioxide (SiO2)	112945-52-5		3.2675	mg
			Supplier	Boron Trioxide (B2O3)	1303-86-2		0.5244	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.0807	mg
Protection coat	0.066			Acrylate monomer	proprietary data		0.0066	mg
			Supplier	1-Methoxy-2-propanol	107-98-2		0.0165	mg
			Supplier	Acrylic Resin A	Proprietary Data		0.0297	mg
			Supplier	Organic pigment	Proprietary Data		0.0066	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0066	mg
Solder Ball	0.483		Supplier	Silver (Ag)	7440-22-4		0.0145	mg
			Supplier	Tin (Sn)	7440-31-5		0.4661	mg
			Supplier	Copper (Cu)	7440-50-8		0.0024	mg